

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	ATTORNEY DOCKET NO. CONFIRMATION NO.		
10/633,434	08/01/2003	Dalson Ye Seng Kim	02-1467 4542			
22823 7	7590 10/28/2004		EXAM	EXAMINER		
STEPHEN A	GRATTON FICE OF STEVE GRA	LEE, HSIE	LEE, HSIEN MING			
2764 SOUTH		ART UNIT	PAPER NUMBER			
LAKEWOOD,	, CO 80228	2823	2823			
			DATE MAILED: 10/28/2004	DATE MAILED: 10/28/2004		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application N	0.	Applicant(s)	Į.			
		10/633,434		KIM ET AL.				
	Office Action Summary	Examiner		Art Unit				
		Hsien-Ming L	ee	2823				
Period fo	The MAILING DATE of this communication or Reply	n appears on the co	er sheet with the co	orrespondence ad	dress			
THE - Exte after - If the - If NC - Failu	ORTENED STATUTORY PERIOD FOR R MAILING DATE OF THIS COMMUNICATION Insigns of time may be available under the provisions of 37 Communication SIX (6) MONTHS from the mailing date of this communication period for reply specified above is less than thirty (30) days, period for reply is specified above, the maximum statutory provided for reply within the set or extended period for reply will, by reply received by the Office later than three months after the end patent term adjustment. See 37 CFR 1.704(b).	ON. FR 1.136(a). In no event, he on. a reply within the statutory period will apply and will expostatute, cause the application	owever, may a reply be time minimum of thirty (30) days re SIX (6) MONTHS from to n to become ABANDONED	ely filed will be considered timely he mailing date of this co (35 U.S.C. § 133).				
Status								
1)⊠	Responsive to communication(s) filed on	23 August 2004.						
2a)⊠	This action is FINAL . 2b)	This action is non-f	inal.					
3)	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.							
Disposit	ion of Claims							
5)⊠ 6)⊠ 7)□	Claim(s) 1-36 and 64-75 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. Claim(s) 1-13,20-36 and 64-75 is/are allowed. Claim(s) 14-19 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/or election requirement.							
Applicat	ion Papers							
9)[The specification is objected to by the Exa	ıminer.						
10)	The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.							
	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
11)□	Replacement drawing sheet(s) including the carry the oath or declaration is objected to by the	•			• •			
Priority (ınder 35 U.S.C. § 119							
12) <u>□</u> a)	Acknowledgment is made of a claim for fo All b) Some * c) None of: 1. Certified copies of the priority documents. 2. Certified copies of the priority documents. 3. Copies of the certified copies of the application from the International Base the attached detailed Office action for	ments have been re ments have been re priority documents ureau (PCT Rule 17	ceived. ceived in Application have been receive (.2(a)). copies not receive	on No d in this National	Stage			
Attachmen	t(s)			W	10/2004			
1)	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-94 mation Disclosure Statement(s) (PTO-1449 or PTO/Str No(s)/Mail Date 102004. 8/83/04		Interview Summary Paper No(s)/Mail Da Notice of Informal Pa Other:	te	D-152)			

Application/Control Number: 10/633,434

Art Unit: 2823

DETAILED ACTION

Remarks

- 1. The objection to drawing and rejection to claims 1-13 and 20-75 are withdrawn.
- 2. Claims 1-36 and 64-75 are pending in the application.

Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 4. Claims 14-19 are rejected under 35 U.S.C. 102(e) as being anticipated by Farnworth et al. (US 6,451,624).

The applied reference has a common assignee with the instant application. Based upon the earlier effective U.S. filing date of the reference, it constitutes prior art under 35 U.S.C. 102(e). This rejection under 35 U.S.C. 102(e) might be overcome either by a showing under 37 CFR 1.132 that any invention disclosed but not claimed in the reference was derived from the inventor of this application and is thus not the invention "by another," or by an appropriate showing under 37 CFR 1.131.

In re claims 14 and 17, Farnworth et al., in Figs. 2A-2E, 3 and 4 and related text, teach the claimed semiconductor component, comprising:

• a lead frame 58 comprising a plurality of lead fingers 60, a plurality of interconnect bonding sites 66 on the lead fingers 60, a plurality of terminal bonding sites 40/52 on

the lead fingers 60 (Fig.2e) in an area array as shown in Fig.3 and at least one bus bar 64 in the area array electrically connecting selected lead fingers 60 (Fig 3);

- a semiconductor die 14 comprising a circuit side (i.e. a top surface), a plurality of die contacts 30 on the circuit side, and a back side attached to the lead frame 58;
- a plurality of interconnects 32 bonded to the die contacts 30 and to the interconnect bonding sites 66 (Fig.2D);
- a plurality of terminal contacts 54 on the terminal bonding sites 40/52 (Fig.2E); and
- an encapsulant 18 encapsulating the die 14 and the lead frame 58.

In re claims 15 and 16, Farnworth et al. teach that the interconnect bonding sites 66 are located proximate to an outer periphery of the lead frame 58 (Fig. 2E) and the bus bar 64 is located proximate to an inner portion of the lead frame 58 (Fig.3); and the interconnect bonding sites 66 are located relative to the bus bars 64 such that the interconnects 32 do not cross the bus bars 64.

In re claim 18, Farnworth et al. teach that the terminal contacts 54 comprises balls and the terminal bonding sites 40/52 are arranged in a grid array (Fig.1C).

In re claim 19, Farnworth et al. teach that the interconnect bonding sites 66 comprise first metal layers (i.e. silver or gold, col. 5, lines 44-46) on a first side of the lead fingers 60 and the terminal bonding sites 40/52 comprise second metal layers (on an opposing second side of the lead fingers 60.

Allowable Subject Matter

- 5. Claims 1-13, 20-36 and 64-75 are allowed.
- 6. The following is a statement of reasons for the indication of allowable subject matter:

Application/Control Number: 10/633,434

Art Unit: 2823

The closest prior art of record, Farnworth et al. (US 6,451,624), teach a related art.

However, Farnworth et al. fail to teach or suggest that the bus bar connected to selected *terminal bonding sites* (claim 1); the semiconductor die substantially *covering the bus bar* (claims 5, 20, 64 and 70); bus bars proximate to the *inner* portion electrically connecting selected lead fingers (claim 20); and a plurality of interconnect bonding sites on the first side *outside of the die mounting site* (claim 27).

Response to Arguments

7. Applicant's arguments filed 8/23/04 have been fully considered but they are not persuasive for the reason as follows.

In re claim 14, applicant's arguments is on the ground that Farworth et al. although teach plural bus bars 64 as shown in Fig. 3 but these bus bars are trimmed away from the component 10 as illustrated in Fig. 1B (second paragraph, page 13).

In response to the argument, Farworth et al teach that Fig. 3 is a plan view (i.e. top view) taken along line 3-3 of Fig.2A, which is not related to Fig.1B, as asserted by the applicant.

Applicant has misinterpreted the teaching of Farworth et al. In fact, Farworth et al still read on claims 14-19, as stated previously.

For the reasons given above, the rejection is deemed proper.

Conclusion

8. THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO

MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

9. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Hsien-Ming Lee whose telephone number is 571-272-1863. The examiner can normally be reached on Tuesday-Thursday ($8:00 \sim 6:00$).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri can be reached on 571-272-1855. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Hsien-Ming Lee Primary Examiner Art Unit 2823

Oct. 26, 2004

